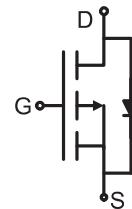


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Description

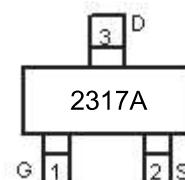
The AP2317A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.



General Features

- $V_{DS} = -20V, I_D = -6A$
- $R_{DS(ON)} < 28m\Omega(\text{max}) @ V_{GS}=-2.5V$
- $R_{DS(ON)} < 20m\Omega(\text{max}) @ V_{GS}=-4.5V$
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Schematic diagram



Marking and pin assignment

Application

- PWM applications
- Load switch
- Power management
- Halogen-free
- P/N suffix V means AEC-Q101 qualified, e.g.:RM2333V



SOT-23-3 top view

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2317A	AP2317A	SOT-23-3	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current -Continuous	I_D	-6	A
Drain Current -Pulsed ^(Note 1)	I_{DM}	-24	A
Maximum Power Dissipation	P_D	1.8	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient ^(Note 2)	$R_{\theta JA}$	69	°C/W
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V _{DSS}	V _{GS} =0V I _D =-250μA	-20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-12V, V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V, V _{DS} =0V	-	-	±100	nA
On Characteristics ^(Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.4	-0.55	-1.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-6A	-	17	20	mΩ
		V _{GS} =-2.5V, I _D =-5A	-	22	28	
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D =-6A		20	-	S
Dynamic Characteristics ^(Note 4)						
Input Capacitance	C _{iss}	V _{DS} =-6V, V _{GS} =0V, F=1.0MHz	-	1730	-	PF
Output Capacitance	C _{oss}		-	320	-	PF
Reverse Transfer Capacitance	C _{rss}		-	210	-	PF
Switching Characteristics ^(Note 4)						
Turn-on Delay Time	t _{d(on)}	V _{DD} =-6V, I _D =-1A , R _L =6Ω, V _{GEN} =-4.5V, R _g =6Ω	-	20	-	nS
Turn-on Rise Time	t _r		-	35	-	nS
Turn-Off Delay Time	t _{d(off)}		-	90	-	nS
Turn-Off Fall Time	t _f		-	70	-	nS
Total Gate Charge	Q _g	V _{DS} =-6V, I _D =-6A, V _{GS} =-4.5V	-	19.5	-	nC
Gate-Source Charge	Q _{gs}		-	4.1	-	nC
Gate-Drain Charge	Q _{gd}		-	5.2	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage ^(Note 3)	V _{SD}	V _{GS} =0V, I _s =-1.0A	-	-	-1.2	V
Diode Forward Current ^(Note 2)	I _s		-	-	-6	A

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

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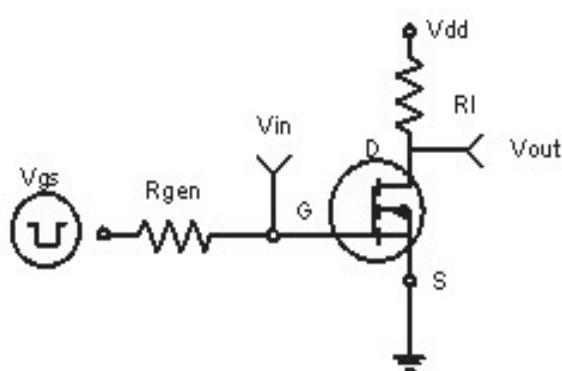


Figure 1:Switching Test Circuit

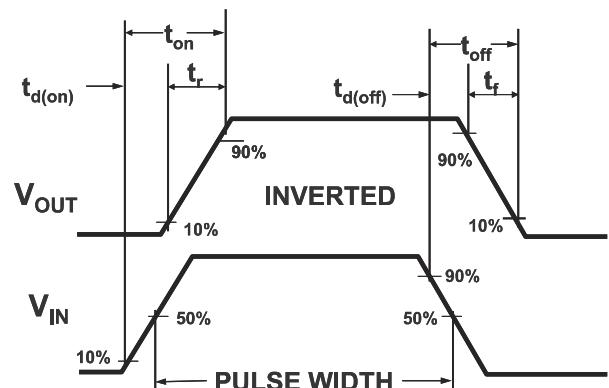


Figure 2:Switching Waveforms

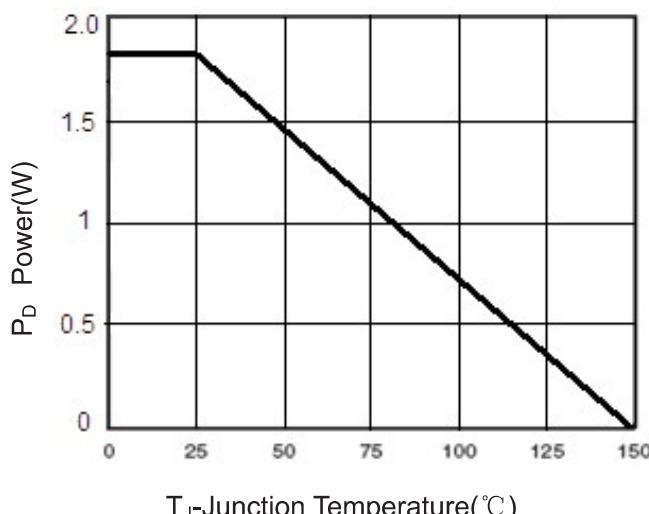


Figure 3 Power Dissipation

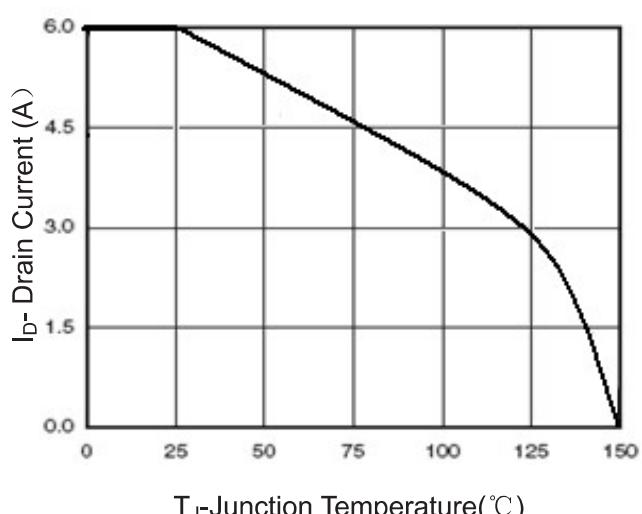


Figure 4 Drain Current

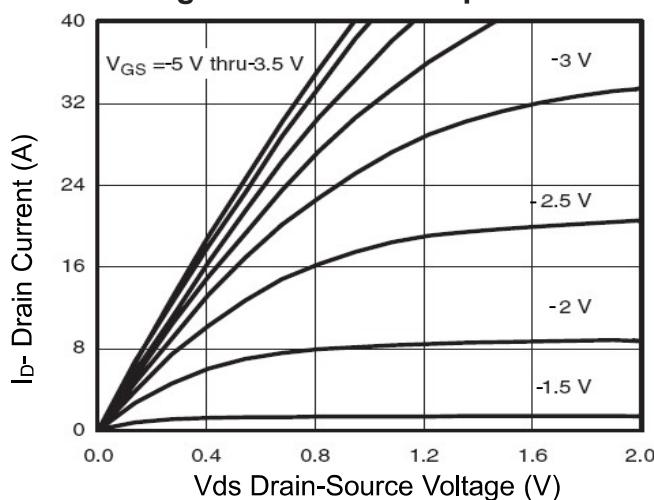


Figure 5 Output Characteristics

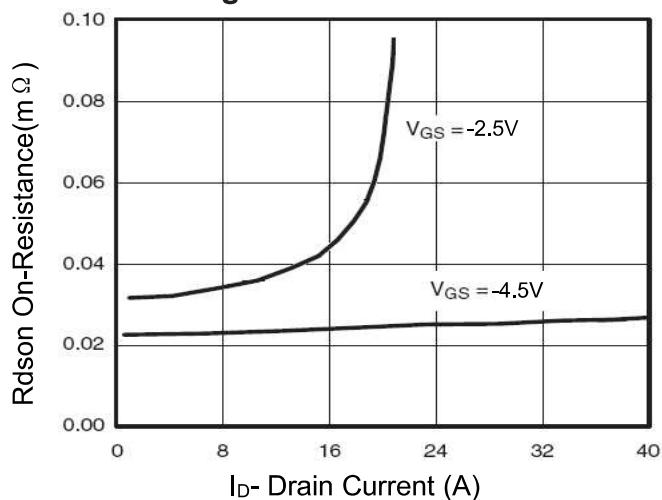


Figure 6 Drain-Source On-Resistance

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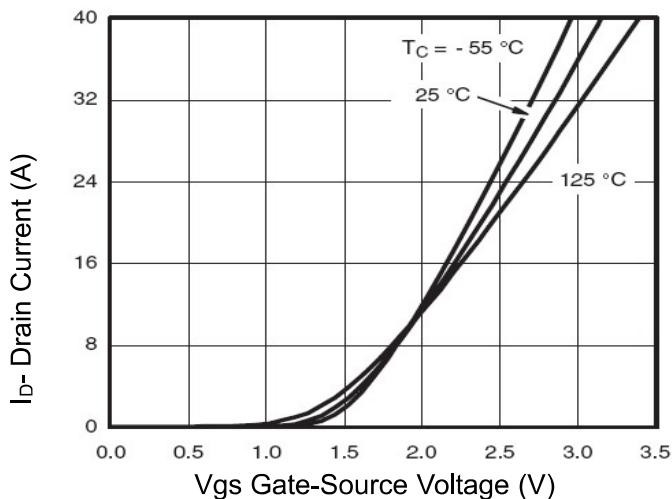


Figure 7 Transfer Characteristics

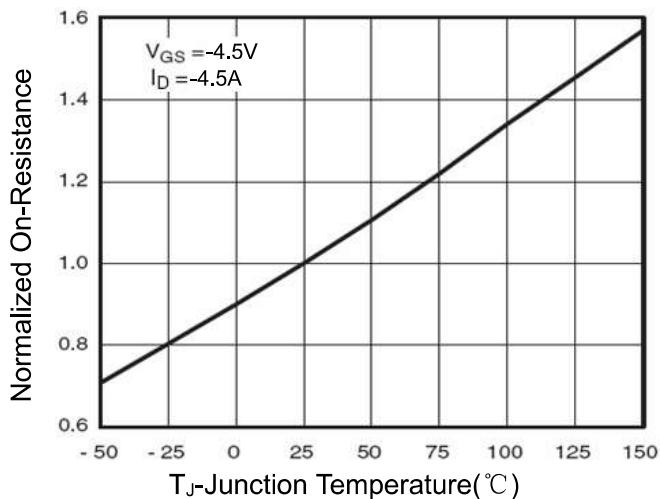


Figure 8 Drain-Source On-Resistance

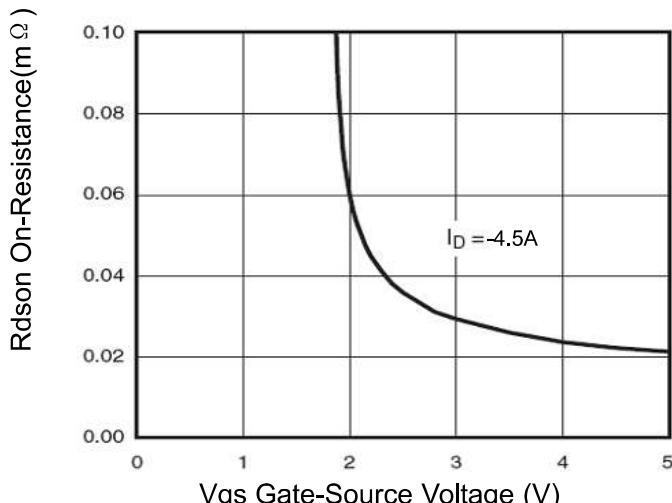


Figure 9 $R_{DS(on)}$ vs V_{GS}

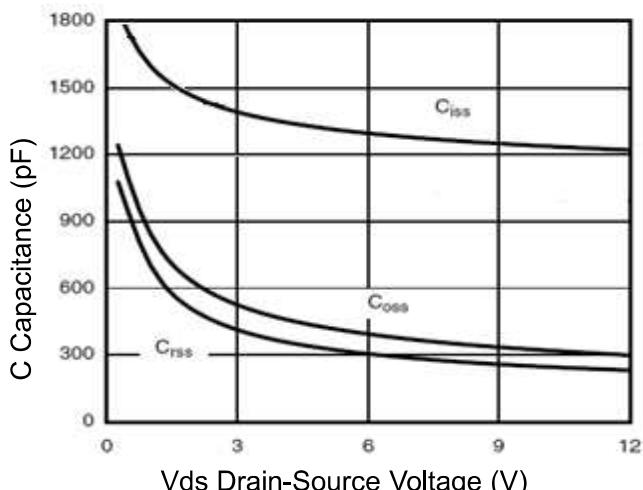


Figure 10 Capacitance vs V_{DS}

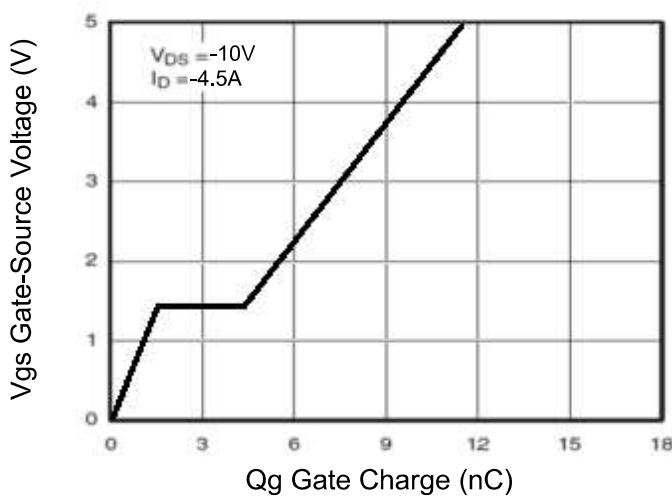


Figure 11 Gate Charge

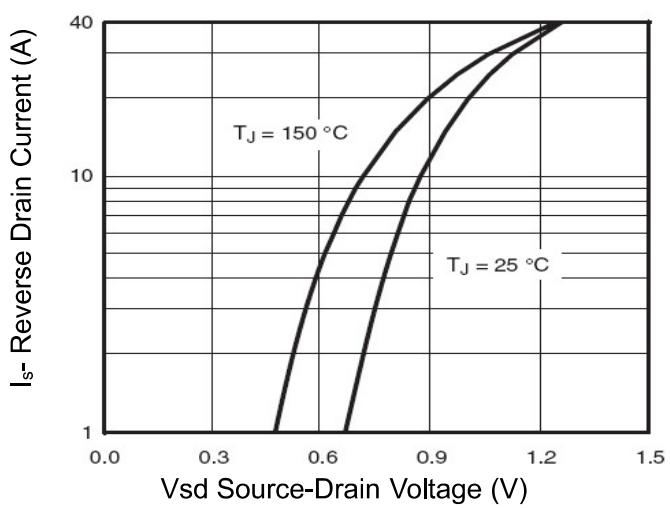


Figure 12 Source-Drain Diode Forward

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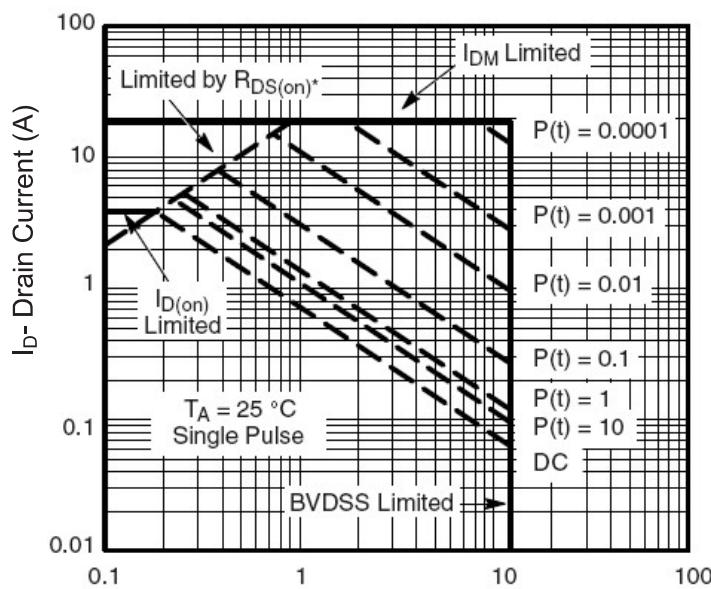


Figure 13 Safe Operation Area

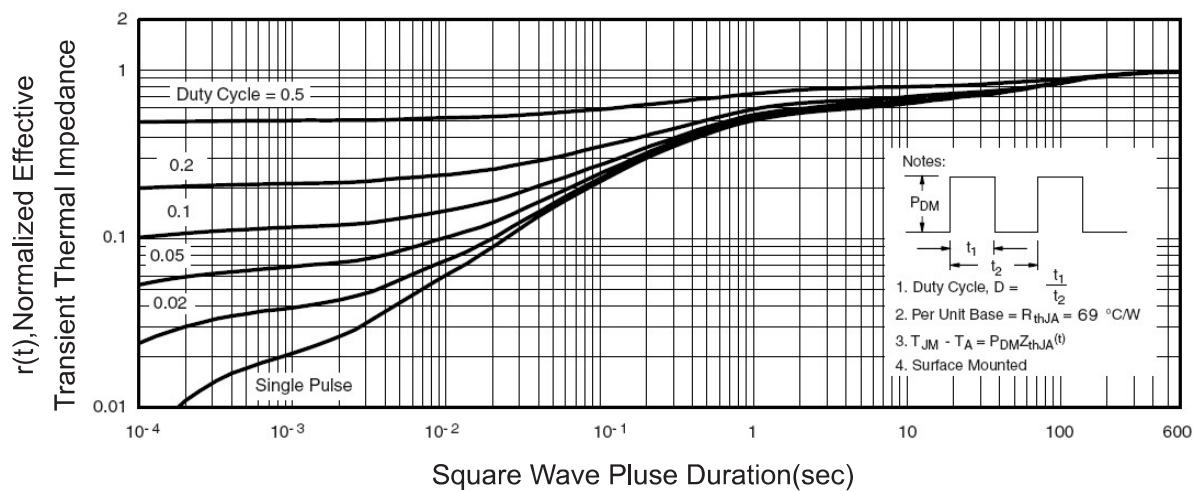


Figure 14 Normalized Maximum Transient Thermal Impedance

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SOT-23-3 Package Information

